

SSC8L62GT8

N-Channel Enhanced MOSFET

> Features

VDS	VGS	RDSON Typ.	ID
60V	±20V	8mR@10V	70A
000	±20V	12.5mR@4V5	70A

> Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS Tested.

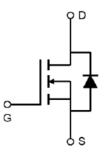
- > Applications
- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

> Ordering Information

Device	Package	Shipping	
SSC8L62GT8	TO252-2L	2500/Reel	

> Pin configuration







Marking

(XX: product year / YY: product week)

> Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit	
V _{DSS}	Drain-to-Source Vol	tage	60	V
V _{GSS}	Gate-to-Source Vol	tage	±20	V
	Questionene Desire Quese et d	Tc=25℃	70	•
lD	Continuous Drain Current ^d	Tc=100℃	36	A
		T _A =25℃	22	
IDSM	Continuous Drain Current ^a	T _A =70°C	16	A
I _{DM}	Pulsed Drain Curre	260	А	
6		Tc=25℃	62.5	14/
PD	Power Dissipation ^c	Tc=100℃	25	W
D	T _A =25℃		6.25	14/
Pdsm	Power Dissipation ^a T _A =70°C		4.0	W
las	Avalanche Current ^b L=0.5ml	18	А	
Eas	Avalanche Energy ^b L=0.5mH Single Pulse		81	mJ
TJ	Operation junction temperature		-55~150	
Tstg	Storage temperature	-55~150	°C	

> Thermal Resistance Ratings($T_A=25^{\circ}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R _{θJA}	Junction-to-Ambient Thermal Resistance ^a	20	°C/W
R _{θJC}	Junction-to-Case Thermal Resistance	2.0	C/ VV

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t ≤ 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

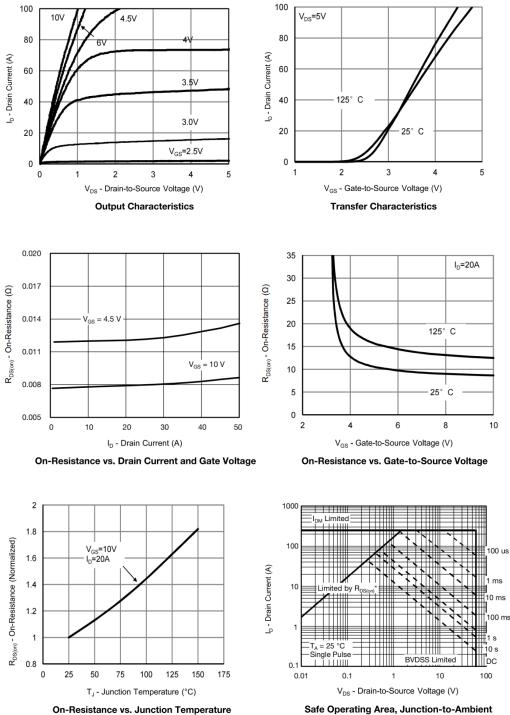


Electronics Characteristics(T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	VGS=0V ,ID=250uA	60			V	
$V_{GS \ (th)}$	Gate Threshold Voltage	VDS=VGS ,ID=250uA	1.0	1.8	2.4	V	
П	Drain-Source On-	VGS=10V , ID=30A		8	9.5	D	
$R_{DS(on)}$	Resistance	VGS=4.5V , ID=20A		12.5	15.5	mR	
I _{DSS}	Zero Gate Voltage Drain Current	VDS=60V ,VGS=0V			1	uA	
I _{GSS}	Gate-Source leak current	VGS=±20V ,VDS=0V			±100	nA	
G _{FS}	Transconductance	VDS=5V ,ID=20A		30		S	
V_{SD}	Forward Voltage	VGS=0V , IS=20A		0.8	1.3	V	
Rg	Gate Resistance	VDS=0V, f=1MHz		1.4		R	
Ciss	Input Capacitance			950			
Coss	Output Capacitance	VDS=30V , VGS=0V,		360		pF	
Crss	Reverse Transfer Capacitance	f=1MHz		24		, pr	
T _{D(ON)}	Turn-on delay time			8			
Tr	Rise time	VGS=10V, RL=1.5R		4			
TD(OFF)	Turn-off delay time	VDS=30V , RG=3R		18		ns	
Tf	Fall time			4.1			
Q _G	Total Gate Charge			16			
Q _{GS}	Gate Source Charge	VGS=10V, VDS=30V		4.4		nC	
Qgd	Gate Drain Charge	- ID=20A		2.5			
Trr	Diode Recovery Time	IF=20A , di/dt=500A/us		24		ns	
Qrr	Diode Recovery Charge	IF=20A , di/dt=500A/us		54		nC	



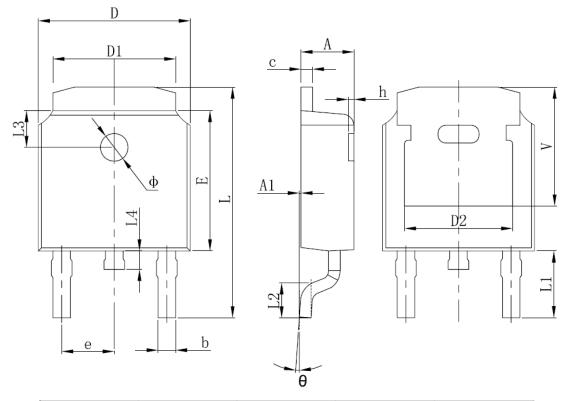
Typical Characteristics(TA=25°C unless otherwise noted) \triangleright



Safe Operating Area, Junction-to-Ambient



> Package Information



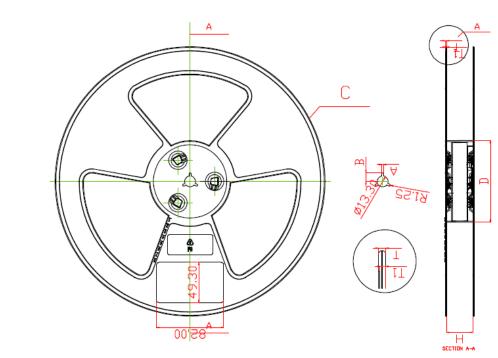
Symbol	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900 REF.		0.114	REF.
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	<mark>8</mark> °	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	

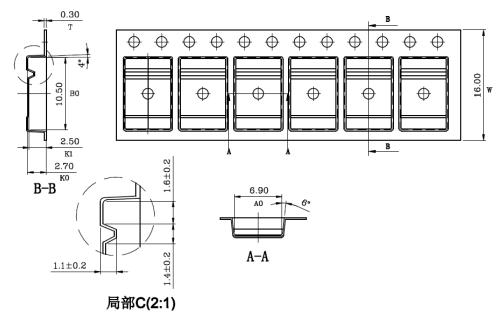


SSC8L62GT8

> Tape and Reel

材质: □	°S	未标准	主公差:	± 0.2
Н	12	16	24	32
C±0,2	330	330	330	330
T1±0.2	1,45	1,45	1,45	1,45
B±0.2	10.7	10.7	10.7	10.7
A±0.2	2.5	2.5	2.5	2.5
T±0.2	1,85	1,85	1,85	1,85
D±0.2	100	100	100	100







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